

To our customers,

Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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Not recommended
for new design

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Renesas Technology Corp.
Customer Support Dept.
April 1, 2003

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2SA1337

Silicon PNP Epitaxial

RENESAS

ADE-208-1014A (Z)
2nd. Edition
Mar. 2001

Application

- Low frequency low noise amplifier
- HF amplifier

Outline

SPAK



1. Emitter
2. Collector
3. Base

Absolute Maximum Ratings (Ta = 25°C)

| Item | Symbol | Ratings | Unit |
|------------------------------|-----------|-------------|------|
| Collector to base voltage | V_{CBO} | -55 | V |
| Collector to emitter voltage | V_{CEO} | -50 | V |
| Emitter to base voltage | V_{EBO} | -5 | V |
| Collector current | I_C | -100 | mA |
| Collector power dissipation | P_C | 300 | mW |
| Junction temperature | T_j | 150 | °C |
| Storage temperature | T_{stg} | -55 to +150 | °C |

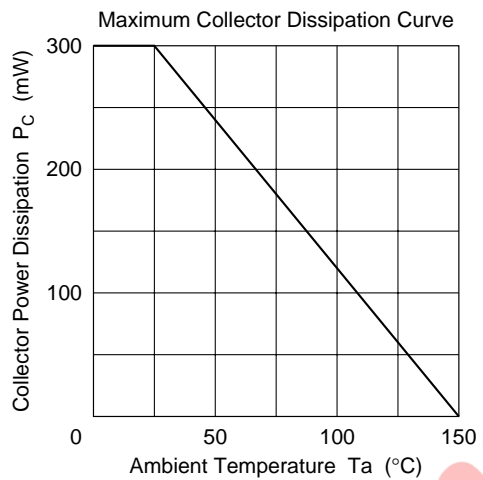
Electrical Characteristics (Ta = 25°C)

| Item | Symbol | Min | Typ | Max | Unit | Test conditions |
|---|---------------|-----|-----|-------|---------|--|
| Collector to base breakdown voltage | $V_{(BR)CBO}$ | -55 | — | — | V | $I_C = -10 \mu A, I_E = 0$ |
| Collector to emitter breakdown voltage | $V_{(BR)CEO}$ | -50 | — | — | V | $I_C = -1 \text{ mA}, R_{BE} = \infty$ |
| Emitter to base breakdown voltage | $V_{(BR)EBO}$ | -5 | — | — | V | $I_E = -10 \mu A, I_C = 0$ |
| Collector cutoff current | I_{CBO} | — | — | -0.5 | μA | $V_{CB} = -18 \text{ V}, I_E = 0$ |
| Emitter cutoff current | I_{EBO} | — | — | -0.5 | μA | $V_{EB} = -2 \text{ V}, I_C = 0$ |
| DC current transfer ratio | h_{FE}^{*1} | 100 | — | 320 | | $V_{CE} = -12 \text{ V}, I_C = -2 \text{ mA}$ |
| Base to emitter voltage | V_{BE} | — | — | -0.75 | V | $V_{CE} = -12 \text{ V}, I_C = -2 \text{ mA}$ |
| Collector to emitter saturation voltage | $V_{CE(sat)}$ | — | — | -0.2 | V | $I_C = -10 \text{ mA}, I_B = -1 \text{ mA}$ |
| Gain bandwidth product | f_T | — | 200 | — | MHz | $V_{CE} = -12 \text{ V}, I_C = -2 \text{ mA}$ |
| Collector output capacitance | C_{ob} | — | — | 4.5 | pF | $V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$ |
| Noise figure | NF | — | 1.0 | 5.0 | dB | $V_{CE} = -6 \text{ V}, I_C = -0.1 \text{ mA}, R_g = 1 \text{ k}\Omega, f = 1 \text{ kHz}$ |

Note: 1. The 2SA1337 is grouped by h_{FE} as follows.

| B | C |
|------------|------------|
| 100 to 200 | 160 to 320 |

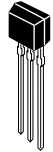
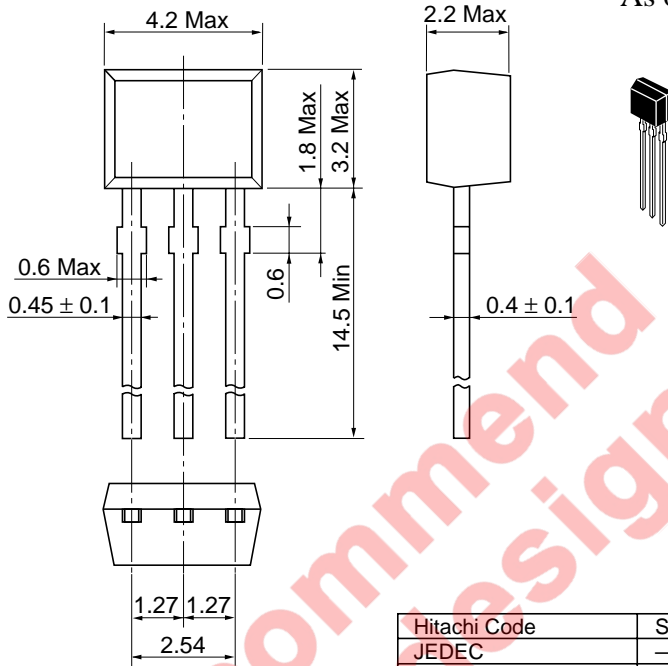
See characteristic curves of 2SA1052.



Not recommend
for new design

Package Dimensions

As of January, 2001
Unit: mm



| | |
|------------------------|--------|
| Hitachi Code | SPAK |
| JEDEC | — |
| EIAJ | — |
| Mass (reference value) | 0.10 g |

Not recommend
for new design

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